

10/04/376 Pro

JCB
866

**PATENT NUMBER and
ISSUE DATE**

U.S. UTILITY Patent Application

APPLICATION	FILING DATE	CLASS	SUBCLASS	GAU	EXAMINER
APPL NUM 10040378	FILING DATE 01/09/2002	CLASS 246		GAU 6 1746	Vinh
**APPLICANTS: Komada Daisuke;					
**CONTINUING DATA VERIFIED:					
** FOREIGN APPLICATIONS VERIFIED: <i>verified</i> LV JAPAN 2001-300562 09/28/2001					
PG-PUB	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>			
Foreign priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no			ATTORNEY DOCKET NO		
35 USC 119 conditions met <input checked="" type="checkbox"/> yes <input type="checkbox"/> no			107317-00040		
Verified and Acknowledged Examiners's initials					
TITLE : Manufacture method for semiconductor device having silicon-containing insulating film					

NOTICE OF ALLOWANCE MAILED		Assistant Examiner	CLAIMS ALLOWED	
			Total Claims	Print Claim for O.G.
ISSUE FEE			DRAWING	
Amount Due	Date Paid		Sheets Drwg.	Fig.s Drwg.
		Primary Examiner		
<input type="checkbox"/> TERMINAL DISCLAIMER		PREPARED FOR ISSUE	Application Examiner	
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